



BTA/BTB24, BTA25, BTA26 and T25 Series

SNUBBERLESS™ & STANDARD

25A TRIACs

MAIN FEATURES:

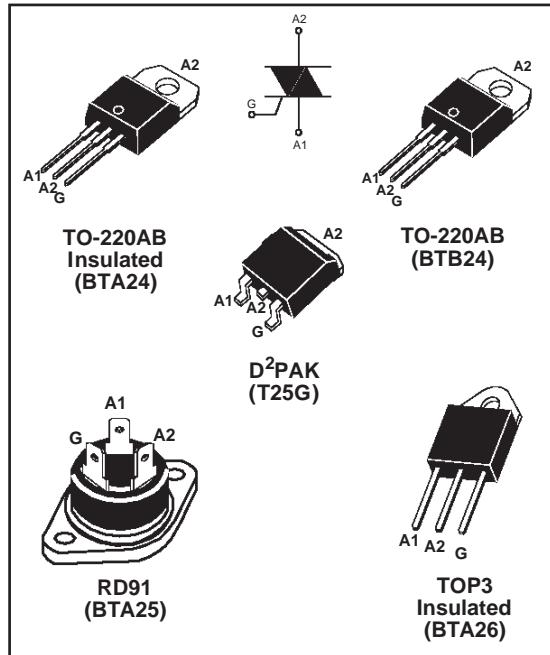
Symbol	Value	Unit
$I_T(\text{RMS})$	25	A
$V_{\text{DRM}}/V_{\text{RRM}}$	600 and 800	V
$I_{\text{GT}}(Q_1)$	35 to 50	mA

DESCRIPTION

Available either in through-hole or surface mount packages, the BTA/BTB24-25-26 triac series is suitable for general purpose AC power switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, water heaters, induction motor starting circuits...or for phase control operation in high power motor speed controllers, soft start circuits...The snubberless versions (BTA/BTB...W and T25 series) are specially recommended for use on inductive loads, thanks to their high commutation performances.

By using an internal ceramic pad, the BTA series provides voltage insulated tab (rated at 2500V RMS) complying with UL standards (File ref.: E81734).

ABSOLUTE MAXIMUM RATINGS



Symbol	Parameter	Value	Unit
$I_T(\text{RMS})$	D PAK TO-220AB	25	A
	RD91 TOP3 Ins.		
	TO-220AB Ins.		
I_{TSM}	F = 60 Hz t = 16.7 ms	260	A
	F = 50 Hz t = 20 ms	250	
I_t	I_t Value for fusing tp = 10 ms	450	A s
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{\text{GT}}$, $t_r \leq 100$ ns	F = 120 Hz $T_j = 125^\circ\text{C}$	50 A/ μs
$V_{\text{DSM}}/V_{\text{RSM}}$	Non repetitive surge peak off-state voltage	tp = 10 ms $T_j = 25^\circ\text{C}$	$V_{\text{DRM}}/V_{\text{RRM}} + 100$ V
I_{GM}	Peak gate current	tp = 20 μs $T_j = 125^\circ\text{C}$	4 A
$P_{\text{G(AV)}}$	Average gate power dissipation	$T_j = 125^\circ\text{C}$	1 W
T_{stg} T_j	Storage junction temperature range Operating junction temperature range	- 40 to + 150 - 40 to + 125	$^\circ\text{C}$

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ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$, unless otherwise specified)

■ SNUBBERLESS™ (3 Quadrants) T25-G, BTA/BTB24...W, BTA25...W, BTA26...W

Symbol	Test Conditions	Quadrant	T25			Unit	
			T2535	CW	BW		
I_{GT} (1)	$V_D = 12 \text{ V}$ $R_L = 33 \Omega$	I - II - III	MAX.	35	35	50	mA
V_{GT}		I - II - III	MAX.	1.3			V
V_{GD}	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ $T_j = 125^\circ\text{C}$	I - II - III	MIN.	0.2			V
I_H (2)	$I_T = 500 \text{ mA}$		MAX.	50	50	75	mA
I_L	$I_G = 1.2 I_{GT}$	I - III	MAX.	70	70	80	mA
		II		80	80	100	
dV/dt (2)	$V_D = 67 \% V_{DRM}$ gate open $T_j = 125^\circ\text{C}$		MIN.	500	500	1000	V/ μs
(dV/dt)c (2)	Without snubber $T_j = 125^\circ\text{C}$		MIN.	13	13	22	A/ms

■ STANDARD (4 Quadrants): BTA25...B, BTA26...B

Symbol	Test Conditions	Quadrant		Value	Unit	
I_{GT} (1)	$V_D = 12 \text{ V}$ $R_L = 33 \Omega$	I - II - III	MAX.	50	mA	
		IV		100		
V_{GT}		ALL	MAX.	1.3	V	
		ALL		0.2	V	
I_H (2)	$I_T = 500 \text{ mA}$	ALL	MAX.	80	mA	
		ALL		70		
I_L	$I_G = 1.2 I_{GT}$	I - III - IV	MAX.	160	mA	
		II		160		
dV/dt (2)	$V_D = 67 \% V_{DRM}$ gate open $T_j = 125^\circ\text{C}$		MIN.	500	V/ μs	
(dV/dt)c (2)	(dV/dt)c = 13.3 A/ms $T_j = 125^\circ\text{C}$		MIN.	10	V/ μs	

STATIC CHARACTERISTICS

Symbol	Test Conditions			Value	Unit
V_{TM} (2)	$I_{TM} = 35 \text{ A}$ $tp = 380 \mu\text{s}$	$T_j = 25^\circ\text{C}$	MAX.	1.55	V
V_{to} (2)	Threshold voltage	$T_j = 125^\circ\text{C}$	MAX.	0.85	V
R_d (2)	Dynamic resistance	$T_j = 125^\circ\text{C}$	MAX.	16	m Ω
I_{DRM}	$V_{DRM} = V_{RRM}$	$T_j = 25^\circ\text{C}$	MAX.	5	μA
		$T_j = 125^\circ\text{C}$		3	mA

Note 1: minimum IGT is guaranteed at 5% of IGT max.

Note 2: for both polarities of A2 referenced to A1

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case (AC)		D PAK TO-220AB	0.8
	RD91 (Insulated) TOP3 Insulated		1.1	$^{\circ}\text{C/W}$
	TO-220AB Insulated		1.7	
$R_{th(j-a)}$	Junction to ambient S = 1 cm		D PAK TOP3 Insulated TO-220AB	45 50 60
	TO-220AB Insulated			

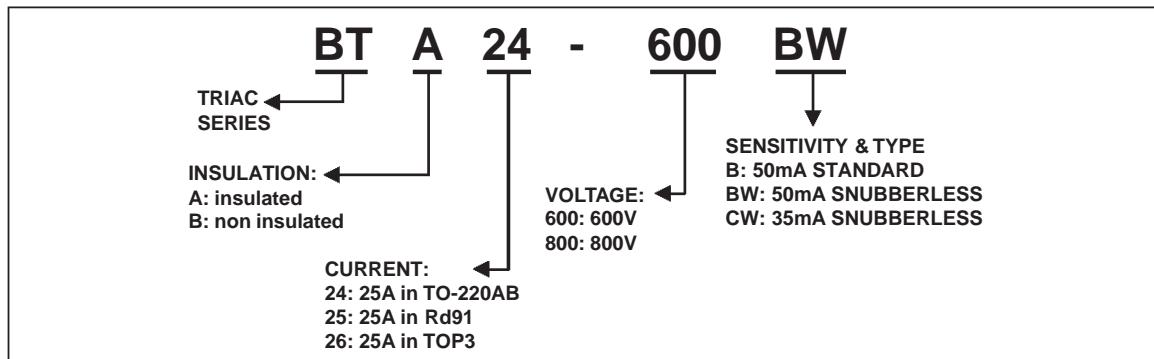
S: Copper surface under tab

PRODUCT SELECTOR

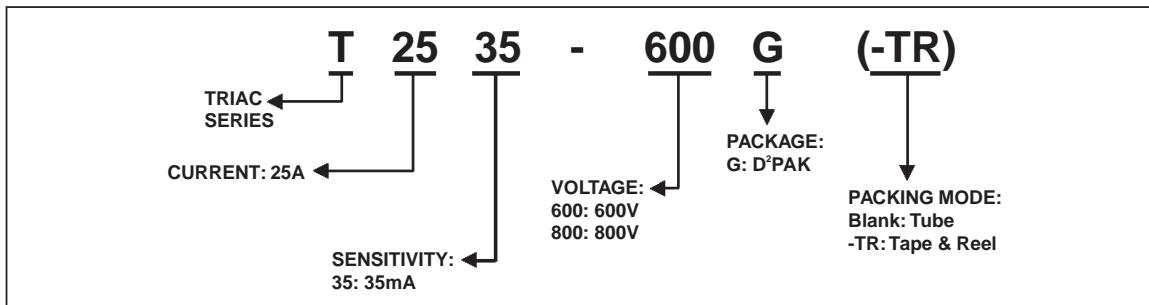
Part Number	Voltage (xxx)		Sensitivity	Type	Package
	600 V	800 V			
BTB24-xxxB	X	X	50 mA	Standard	TO-220AB
BTA/BTB24-xxxBW	X	X	50 mA	Snubberless	TO-220AB
BTA/BTB24-xxxCW	X	X	35 mA	Snubberless	TO-220AB
BTA25-xxxB	X	X	50 mA	Standard	RD-91
BTA25-xxxBW	X	X	50 mA	Snubberless	RD-91
BTA25-xxxCW	X	X	35 mA	Snubberless	RD-91
BTA26-xxxB	X	X	50 mA	Standard	TOP3 Ins.
BTA26-xxxBW	X	X	50 mA	Snubberless	TOP3 Ins.
BTA26-xxxCW	X	X	35 mA	Snubberless	TOP3 Ins.
T2535-xxxF	X	X	35 mA	Snubberless	D PAK

BTB: Non insulated TO-220AB package

ORDERING INFORMATION



BTA/BTB24, BTA25, BTA26 and T25 Series



OTHER INFORMATION

Part Number	Marking	Weight	Base quantity	Packing mode
BTA/BTB24-xxxxz	BTA/BTB24xxxxz	2.3 g	250	Bulk
BTA25-xxxxz	BTA25xxxxz	20 g	25	Bulk
BTA26-xxxxz	BTA26xxxxz	4.5 g	120	Bulk
T2535-xxxG	T2535xxxG	1.5 g	50	Tube
T2535-xxxG-TR	T2535xxxG	1.5 g	1000	Tape & reel

Note: xxx= voltage, y = sensitivity, z = type

Fig. 1: Maximum power dissipation versus RMS on-state current (full cycle).

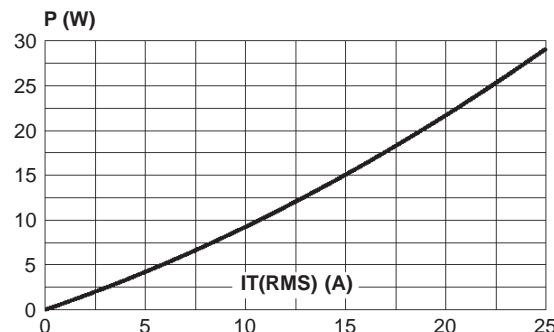


Fig. 2-2: D PAK RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35 μm), full cycle.

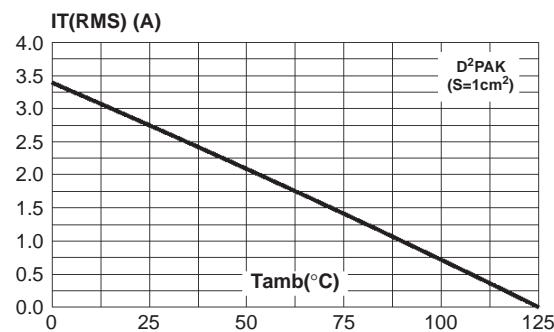


Fig. 4: On-state characteristics (maximum values).

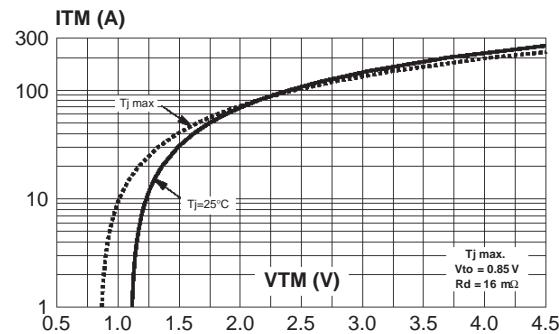


Fig. 2-1: RMS on-state current versus case temperature (full cycle).

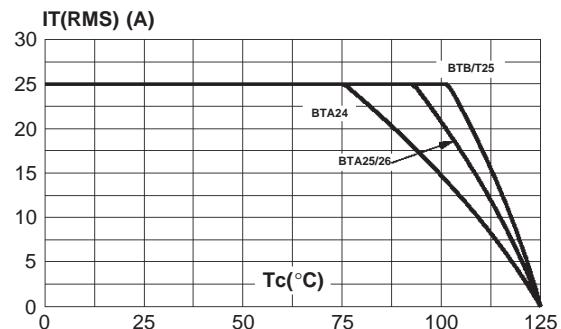


Fig. 3: Relative variation of thermal impedance versus pulse duration.

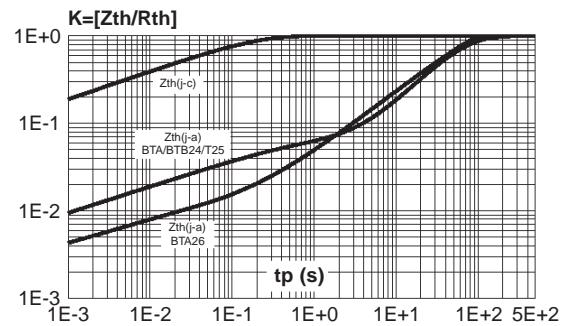


Fig. 5: Surge peak on-state current versus number of cycles.

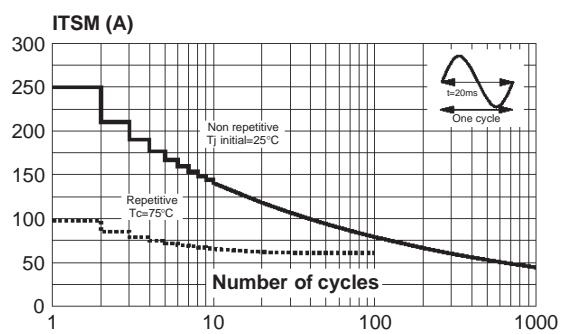


Fig. 6: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10\text{ms}$, and corresponding value of I_t .

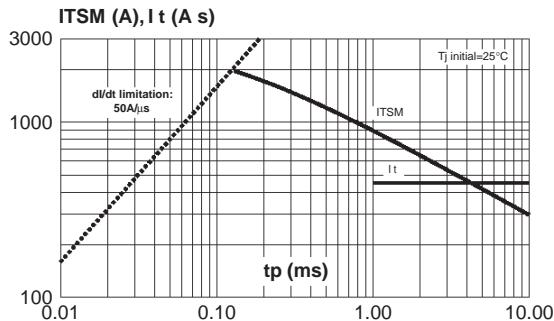


Fig. 8: Relative variation of critical rate of decrease of main current versus $(dV/dt)_c$ (typical values).

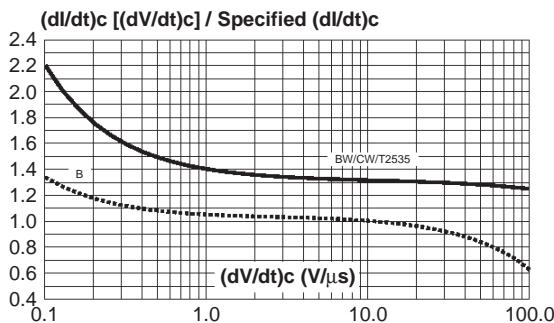


Fig. 10: D PAK Thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: $35\ \mu\text{m}$).

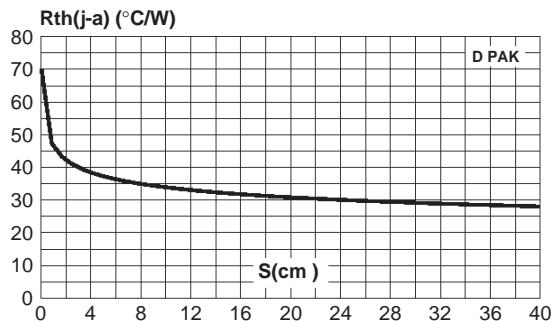


Fig. 7: Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values).

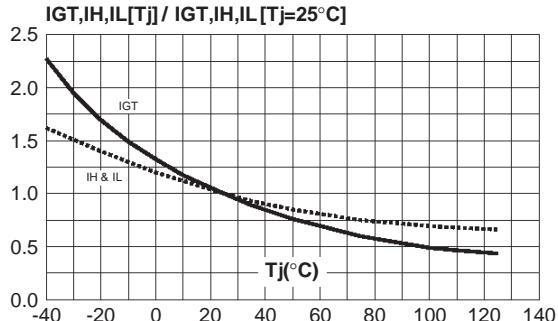
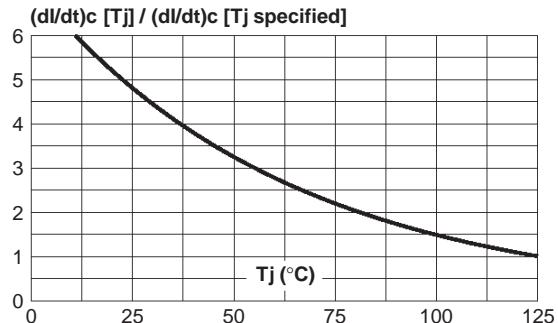


Fig. 9: Relative variation of critical rate of decrease of main current versus junction temperature.



PACKAGE MECHANICAL DATA

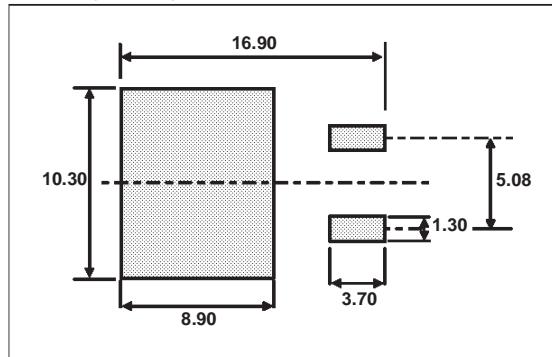
D PAK (Plastic)

The diagram illustrates the 3D mechanical dimensions of the D PAK (Plastic) package. It shows a top view and a side view. Key dimensions include:
 - Top View: L (length), L2 (width), L3 (height), E (lead width), G (lead thickness), B2 (lead height), B (lead thickness), C2 (lead thickness), A (lead thickness), A1 (lead thickness), A2 (lead thickness), C (lead thickness), R (lead radius), and V2 (lead angle).
 - Side View: D (height), A (lead thickness), C2 (lead thickness), and R (lead radius).
 - Note: A 2.0 MIN. FLAT ZONE is indicated at the bottom of the lead.
 - Dimensions: L = 15.00, L2 = 1.27, L3 = 1.40, E = 10.00, G = 4.88, B2 = 1.25, B = 0.70, C2 = 1.21, A = 4.30, A1 = 2.49, A2 = 1.40, C = 0.45, R = 0.40, V2 = 0°.

REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.169		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.70		0.93	0.027		0.037
B2	1.25	1.40		0.048	0.055	
C	0.45		0.60	0.017		0.024
C2	1.21		1.36	0.047		0.054
D	8.95		9.35	0.352		0.368
E	10.00		10.28	0.393		0.405
G	4.88		5.28	0.192		0.208
L	15.00		15.85	0.590		0.624
L2	1.27		1.40	0.050		0.055
L3	1.40		1.75	0.055		0.069
R		0.40			0.016	
V2	0°		8°	0°		8°

FOOTPRINT DIMENSIONS (in millimeters)

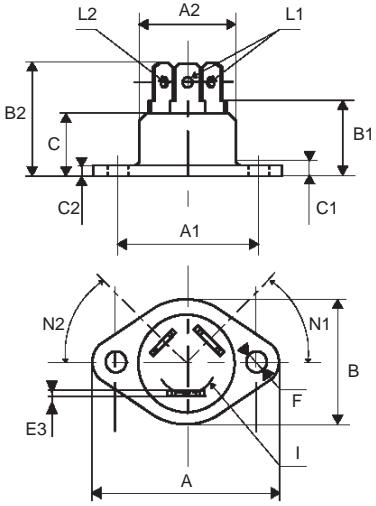
D PAK (Plastic)



BTA/BTB24, BTA25, BTA26 and T25 Series

PACKAGE MECHANICAL DATA

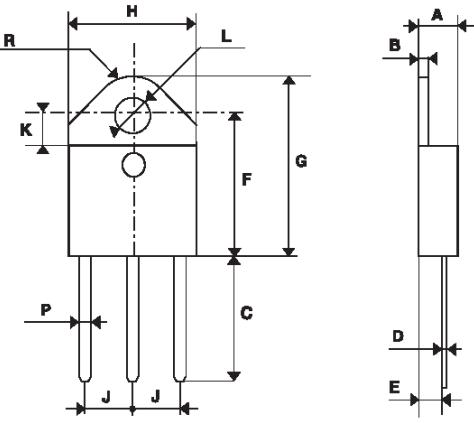
RD91 (Plastic)



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A		40.00		1.575
A1	29.90	30.30	1.177	1.193
A2		22.00		0.867
B		27.00		1.063
B1	13.50	16.50	0.531	0.650
B2		24.00		0.945
C		14.00		0.551
C1		3.50		0.138
C2	1.95	3.00	0.077	0.118
E3	0.70	0.90	0.027	0.035
F	4.00	4.50	0.157	0.177
I	11.20	13.60	0.441	0.535
L1	3.10	3.50	0.122	0.138
L2	1.70	1.90	0.067	0.075
N1	33°	43°	33°	43°
N2	28°	38°	28°	38°

PACKAGE MECHANICAL DATA

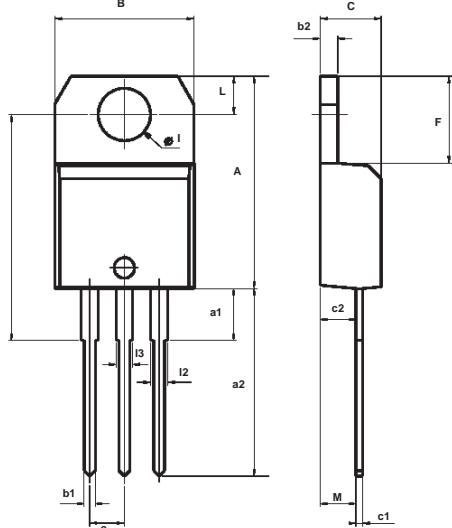
TOP3 (Plastic)



REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.4		4.6	0.173		0.181
B	1.45		1.55	0.057		0.061
C	14.35		15.60	0.565		0.614
D	0.5		0.7	0.020		0.028
E	2.7		2.9	0.106		0.114
F	15.8		16.5	0.622		0.650
G	20.4		21.1	0.815		0.831
H	15.1		15.5	0.594		0.610
J	5.4		5.65	0.213		0.222
K	3.4		3.65	0.134		0.144
L	4.08		4.17	0.161		0.164
P	1.20		1.40	0.047		0.055
R		4.60			0.181	

PACKAGE MECHANICAL DATA

TO-220AB (Plastic)



REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
I	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
I3	1.14		1.70	0.044		0.066
M		2.60			0.102	

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